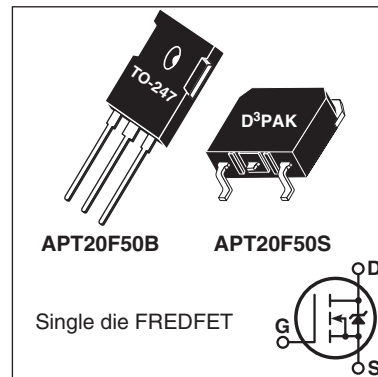


## N-Channel FREDFET

Power MOS 8™ is a high speed, high voltage N-channel switch-mode power MOSFET. This 'FREDFET' version has a drain-source (body) diode that has been optimized for high reliability in ZVS phase shifted bridge and other circuits through reduced  $t_{rr}$ , soft recovery, and high recovery  $dv/dt$  capability. Low gate charge, high gain, and a greatly reduced ratio of  $C_{rss}/C_{iss}$  result in excellent noise immunity and low switching loss. The intrinsic gate resistance and capacitance of the poly-silicon gate structure help control  $di/dt$  during switching, resulting in low EMI and reliable paralleling, even when switching at very high frequency.



## FEATURES

- Fast switching with low EMI
- Low  $t_{rr}$  for high reliability
- Ultra low  $C_{rss}$  for improved noise immunity
- Low gate charge
- Avalanche energy rated
- RoHS compliant 

## TYPICAL APPLICATIONS

- ZVS phase shifted and other full bridge
- Half bridge
- PFC and other boost converter
- Buck converter
- Single and two switch forward
- Flyback

## Absolute Maximum Ratings

| Symbol   | Parameter                                            | Ratings | Unit |
|----------|------------------------------------------------------|---------|------|
| $I_D$    | Continuous Drain Current @ $T_C = 25^\circ\text{C}$  | 20      | A    |
|          | Continuous Drain Current @ $T_C = 100^\circ\text{C}$ | 13      |      |
| $I_{DM}$ | Pulsed Drain Current <sup>①</sup>                    | 60      |      |
| $V_{GS}$ | Gate-Source Voltage                                  | ±30     | V    |
| $E_{AS}$ | Single Pulse Avalanche Energy <sup>②</sup>           | 405     | mJ   |
| $I_{AR}$ | Avalanche Current, Repetitive or Non-Repetitive      | 10      | A    |

## Thermal and Mechanical Characteristics

| Symbol          | Characteristic                                         | Min | Typ  | Max  | Unit               |
|-----------------|--------------------------------------------------------|-----|------|------|--------------------|
| $P_D$           | Total Power Dissipation @ $T_C = 25^\circ\text{C}$     |     |      | 290  | W                  |
| $R_{\theta JC}$ | Junction to Case Thermal Resistance                    |     |      | 0.43 | $^\circ\text{C/W}$ |
| $R_{\theta CS}$ | Case to Sink Thermal Resistance, Flat, Greased Surface |     | 0.15 |      |                    |
| $T_J, T_{STG}$  | Operating and Storage Junction Temperature Range       | -55 |      | 150  | $^\circ\text{C}$   |
| $T_L$           | Soldering Temperature for 10 Seconds (1.6mm from case) |     |      | 300  |                    |
| $W_T$           | Package Weight                                         |     | 0.22 |      | oz                 |
|                 |                                                        |     | 6.2  |      | g                  |
| Torque          | Mounting Torque ( TO-247 Package), 6-32 or M3 screw    |     |      | 10   | in-lbf             |
|                 |                                                        |     |      | 1.1  | N-m                |

**Static Characteristics**
**T<sub>J</sub> = 25°C unless otherwise specified**
**AP20F50B\_S**

| Symbol                          | Parameter                                 | Test Conditions                           | Min | Typ  | Max       | Unit     |
|---------------------------------|-------------------------------------------|-------------------------------------------|-----|------|-----------|----------|
| $V_{BR(DSS)}$                   | Drain-Source Breakdown Voltage            | $V_{GS} = 0V, I_D = 250\mu A$             | 500 |      |           | V        |
| $\Delta V_{BR(DSS)}/\Delta T_J$ | Breakdown Voltage Temperature Coefficient | Reference to 25°C, $I_D = 250\mu A$       |     | 0.60 |           | V/°C     |
| $R_{DS(on)}$                    | Drain-Source On Resistance <sup>③</sup>   | $V_{GS} = 10V, I_D = 10A$                 |     | 0.25 | 0.30      | $\Omega$ |
| $V_{GS(th)}$                    | Gate-Source Threshold Voltage             | $V_{GS} = V_{DS}, I_D = 0.5mA$            | 2.5 | 4    | 5         | V        |
| $\Delta V_{GS(th)}/\Delta T_J$  | Threshold Voltage Temperature Coefficient |                                           |     | -10  |           | mV/°C    |
| $I_{DSS}$                       | Zero Gate Voltage Drain Current           | $V_{DS} = 500V$<br>$V_{GS} = 0V$          |     |      | 100       | $\mu A$  |
|                                 |                                           | $T_J = 25^\circ C$<br>$T_J = 125^\circ C$ |     |      | 500       |          |
| $I_{GSS}$                       | Gate-Source Leakage Current               | $V_{GS} = \pm 30V$                        |     |      | $\pm 100$ | nA       |

**Dynamic Characteristics**
**T<sub>J</sub> = 25°C unless otherwise specified**

| Symbol          | Parameter                                    | Test Conditions                                                                                | Min | Typ  | Max | Unit |
|-----------------|----------------------------------------------|------------------------------------------------------------------------------------------------|-----|------|-----|------|
| $g_{fs}$        | Forward Transconductance                     | $V_{DS} = 50V, I_D = 10A$                                                                      |     | 14   |     | S    |
| $C_{iss}$       | Input Capacitance                            | $V_{GS} = 0V, V_{DS} = 25V$<br>$f = 1MHz$                                                      |     | 2950 |     | pF   |
| $C_{rss}$       | Reverse Transfer Capacitance                 |                                                                                                |     | 40   |     |      |
| $C_{oss}$       | Output Capacitance                           |                                                                                                |     | 320  |     |      |
| $C_{o(cr)}^{④}$ | Effective Output Capacitance, Charge Related | $V_{GS} = 0V, V_{DS} = 0V \text{ to } 333V$                                                    |     | 185  |     |      |
| $C_{o(er)}^{⑤}$ | Effective Output Capacitance, Energy Related |                                                                                                |     | 95   |     |      |
| $Q_g$           | Total Gate Charge                            | $V_{GS} = 0 \text{ to } 10V, I_D = 10A,$<br>$V_{DS} = 250V$                                    |     | 75   |     | nC   |
| $Q_{gs}$        | Gate-Source Charge                           |                                                                                                |     | 17   |     |      |
| $Q_{gd}$        | Gate-Drain Charge                            |                                                                                                |     | 34   |     |      |
| $t_{d(on)}$     | Turn-On Delay Time                           | <b>Resistive Switching</b><br>$V_{DD} = 333V, I_D = 10A$<br>$R_G = 10\Omega^{⑥}, V_{GG} = 15V$ |     | 13   |     | ns   |
| $t_r$           | Current Rise Time                            |                                                                                                |     | 15   |     |      |
| $t_{d(off)}$    | Turn-Off Delay Time                          |                                                                                                |     | 34   |     |      |
| $t_f$           | Current Fall Time                            |                                                                                                |     | 11   |     |      |

**Source-Drain Diode Characteristics**

| Symbol    | Parameter                                       | Test Conditions                                                                  | Min                 | Typ  | Max | Unit    |
|-----------|-------------------------------------------------|----------------------------------------------------------------------------------|---------------------|------|-----|---------|
| $I_S$     | Continuous Source Current (Body Diode)          | MOSFET symbol showing the integral reverse p-n junction diode (body diode)       |                     |      | 20  | A       |
| $I_{SM}$  | Pulsed Source Current (Body Diode) <sup>①</sup> |                                                                                  |                     |      | 60  |         |
| $V_{SD}$  | Diode Forward Voltage                           | $I_{SD} = 10, T_J = 25^\circ C, V_{GS} = 0V$                                     |                     |      | 1.0 | V       |
| $t_{rr}$  | Reverse Recovery Time                           | $I_{SD} = 10A^{③}$<br>$di_{SD}/dt = 100A/\mu s$<br>$V_{DD} = 100V$               | $T_J = 25^\circ C$  | 175  | 200 | ns      |
|           |                                                 |                                                                                  | $T_J = 125^\circ C$ | 310  | 370 |         |
| $Q_{rr}$  | Reverse Recovery Charge                         |                                                                                  | $T_J = 25^\circ C$  | 0.62 |     | $\mu C$ |
|           |                                                 |                                                                                  | $T_J = 125^\circ C$ | 1.47 |     |         |
| $I_{rrm}$ | Reverse Recovery Current                        |                                                                                  | $T_J = 25^\circ C$  | 6.6  |     | A       |
|           |                                                 |                                                                                  | $T_J = 125^\circ C$ | 8.9  |     |         |
| $dv/dt$   | Peak Recovery dv/dt                             | $I_{SD} \leq 10A, di/dt \leq 1000A/\mu s, V_{DD} = 333V,$<br>$T_J = 125^\circ C$ |                     |      | 20  | V/ns    |

① Repetitive Rating: Pulse width and case temperature limited by maximum junction temperature.

② Starting at  $T_J = 25^\circ C, L = 8.10mH, R_G = 25\Omega, I_{AS} = 10A$ .

③ Pulse test: Pulse Width < 380 $\mu s$ , duty cycle < 2%.

④  $C_{o(cr)}$  is defined as a fixed capacitance with the same stored charge as  $C_{OSS}$  with  $V_{DS} = 67\%$  of  $V_{(BR)DSS}$ .

⑤  $C_{o(er)}$  is defined as a fixed capacitance with the same stored energy as  $C_{OSS}$  with  $V_{DS} = 67\%$  of  $V_{(BR)DSS}$ . To calculate  $C_{o(er)}$  for any value of  $V_{DS}$  less than  $V_{(BR)DSS}$ , use this equation:  $C_{o(er)} = -1.05E-7/V_{DS}^2 + 2.44E-8/V_{DS} + 6.99E-11$ .

⑥  $R_G$  is external gate resistance, not including internal gate resistance or gate driver impedance. (MIC4452)

Microsemi reserves the right to change, without notice, the specifications and information contained herein.

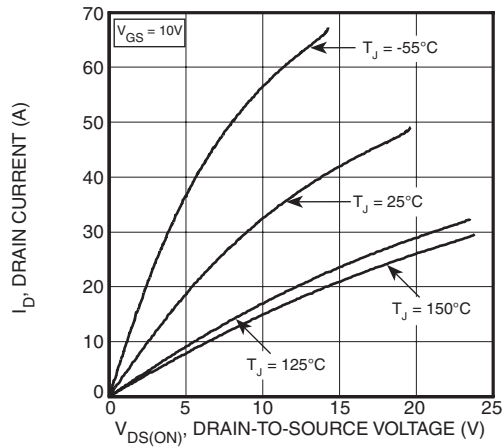


Figure 1, Output Characteristics

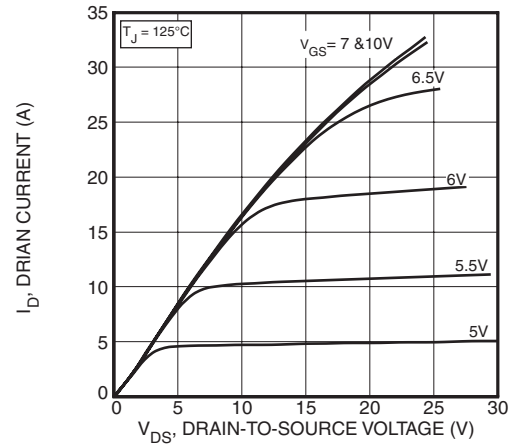


Figure 2, Output Characteristics

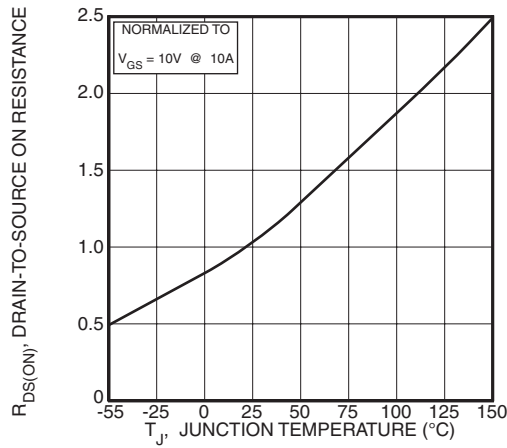
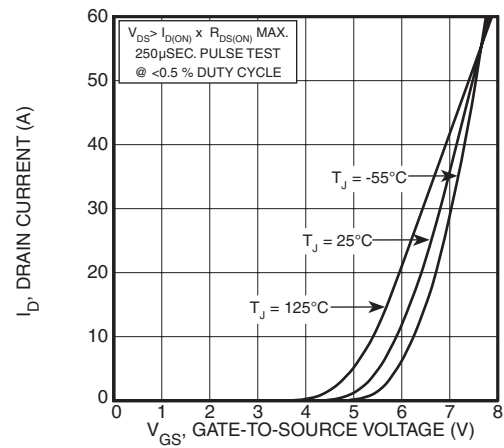
Figure 3,  $R_{DS(ON)}$  vs Junction Temperature

Figure 4, Transfer Characteristics

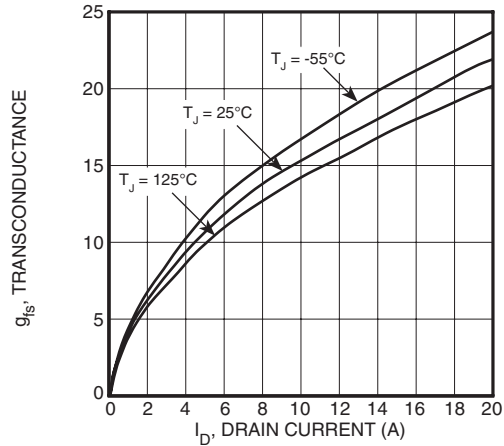


Figure 5, Gain vs Drain Current

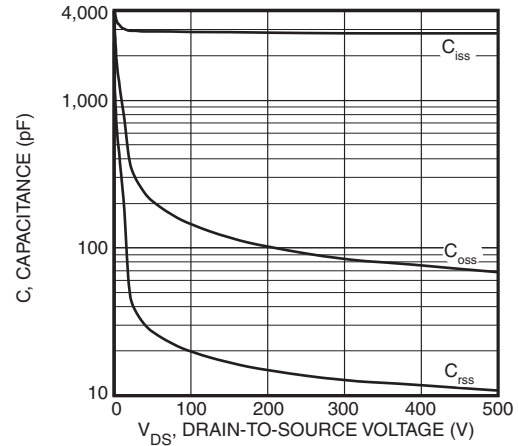


Figure 6, Capacitance vs Drain-to-Source Voltage

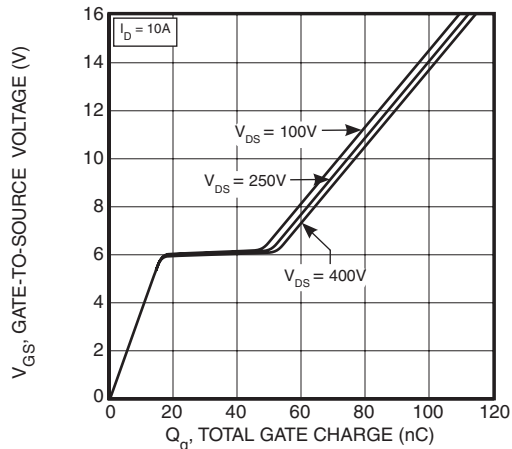


Figure 7, Gate Charge vs Gate-to-Source Voltage

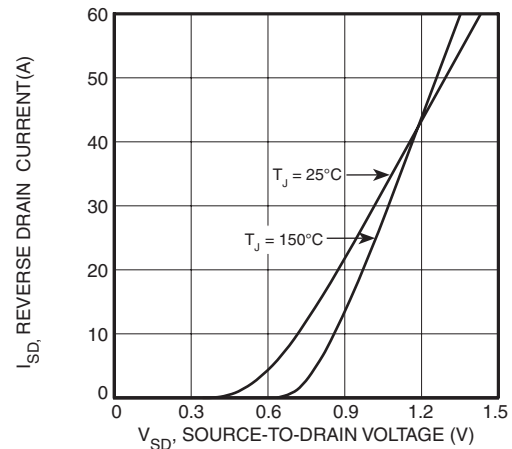


Figure 8, Drain Current vs Source-to-Drain Voltage



## D<sup>3</sup>PAK Package Outline

Figure 1 shows the dimensions of the device. The left drawing is a side view, and the right drawing is a top view. Dimensions are provided in both millimeters and inches.

**Side View Dimensions:**

- Top width: 4.69 (185), 5.31 (209), 1.49 (059), 2.49 (098)
- Bottom width: 0.40 (016), 0.79 (031)
- Bottom width (total): 2.21 (087), 2.59 (102)

**Top View Dimensions:**

- Top width: 15.49 (610), 16.25 (640)
- Top width (total): 6.15 (.242) BSC
- Top width (total): 20.80 (.819), 21.46 (.845)
- Top width (total): 4.50 (.177) Max.
- Top width (total): 19.81 (.780), 20.32 (.800)
- Top width (total): 5.45 (.215) BSC
- Top width (total): 2-Pics.
- Top width (total): 2.87 (111), 3.12 (122), 1.65 (065), 2.13 (084)
- Top width (total): 5.38 (.212), 6.20 (.244)
- Top width (total): 3.50 (.138), 3.81 (.150)

Labels: Drain, Gate, Drain, Source

Dimensions in Millimeters and (Inches)

